

TAI-SAW TECHNOLOGY CO., LTD.

No. 3, Industrial 2nd Rd., Ping-Chen Industrial District, Taoyuan, 324, Taiwan, R.O.C. TEL: 886-3-4690038 FAX: 886-3-4697532

E-mail: tstsales@mail.taisaw.com Web: www.taisaw.com

Product Specifications Approval Sheet

Product Description:	Crystal Unit SMD 2.5	5x2.0 50.0MHz
TST Part No.: TZ345	9B	
Customer Part No.:_		
Customer signature re	equired	
Company:		
Division:		
Approved by :		
Date:		
Checked by:	Chivalry Lin	Chivalky Kelly Huang
Approved by:	Kelly Huang	Kelly Huang
Date:	05/21/2019	

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 2.5x2.0 50.0MHz

MODEL NO.: TZ3459B REV. NO.: 1

Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Revised by
1	N/A	Initial release	05/21/19'	N/A	Chivalry Lin

MODEL NO.: TZ3459B REV. NO.: 1

Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- Moisture Sensitivity Level (MSL): Level-1



Description and Applications:

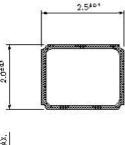
Surface mount 2.5mmx2.0mm crystal unit for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

Electrical Specifications:

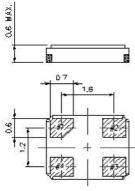
TZ3459B	Specification
Nominal Frequency	50.000000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-55°C to +125°C
Operating Temperature Range	-40°C to +105°C
Frequency Stability over Operating Temperature Range	+/-14 ppm (referred to the value at 25°C)
Frequency Make Tolerance (FL)	+/-3 ppm @ 25°C +/- 3°C
Equivalent Series Resistance (ESR)	15 Ω max
Nominal Drive Level	50uW typical and 350uW max
Shunt Capacitance (Co)	3.0 pF max
Load Capacitance (CL)	19 pF
Aging	+/-2ppm/year
Insulation Resistance	500 MΩ min./DC 100V
Marking	Laser Marking
Unit Weight	9.5 +/-0.5mg

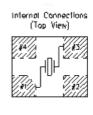
Mechanical Dimensions (mm):

Base

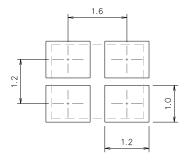


,	Pin Connection
#1 pin	IN/OUT
#2 pin	GND
#3 pin	IN/OUT
#4 pin	GND





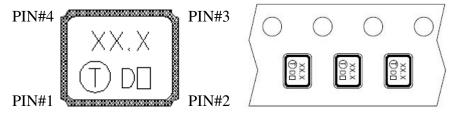
Recommended Land Pattern: (unit: mm)



Marking:

Line 1: Frequency (50.0)

Line 2: TST Logo + Date Code + Product Code (\square is TST internal tracking code, could be a~z and A~Z)



The inner vision of PIN#1,PIN#4 side is XTAL blank mounting pad.

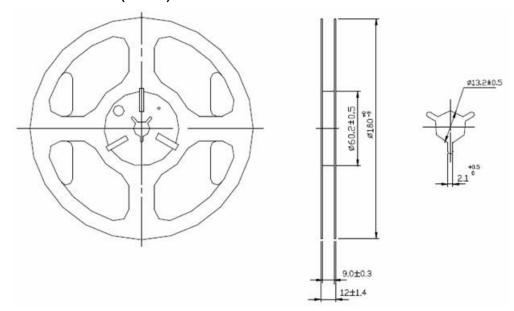
Date Code Table

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
Α	В	С	D	Е	F	G	Н	I	J	K	L	М
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	0	Р	Q	R	S	Т	U	V	W	Х	Υ	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
а	b	С	d	е	f	g	h	i	j	k	I	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	0	р	q	r	s	t	u	V	w	х	у	z

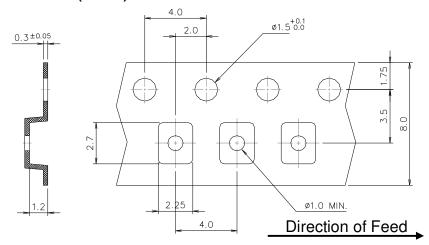
Product Code Table: (Under line With Even Year and Odd Year for Nothing)

Year						Product Code
2013	2015	2017	2019	2021	2023	
2014	2016	2018	2020	2022	2024	

Reel Dimensions (mm):



Tape Dimensions (mm):

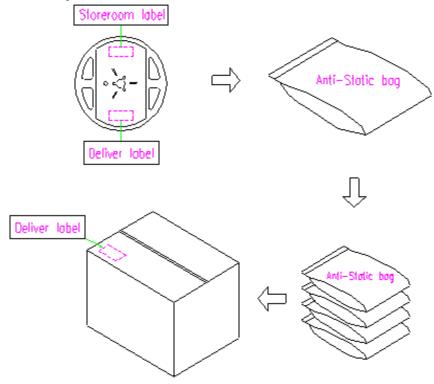


[NOTE]:

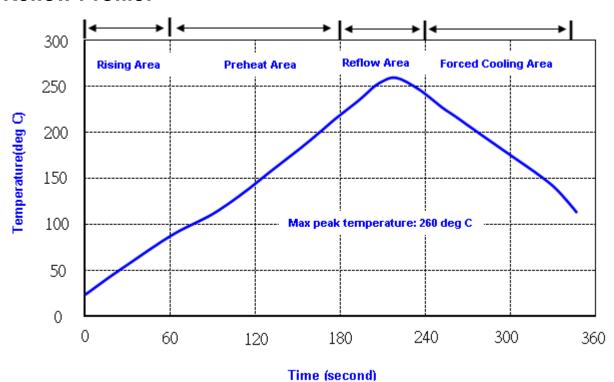
- 1. Unless otherwise specified tolerance on dimension +/-0.1 mm.
- 2. Material: conductive polystyrene with color black.
- 3. 10 pitch cumulative tolerance +/-0.2 mm.

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec

2. Temperature: 217+/-5 deg C; Time: $90\sim100$ sec

Reliability Specifications

Test name	Test process / method	Reference standard				
Mechanical characteristics						
resistance to Soldering heat (IR reflow)	Temp./ Duration: 265°C/10sec ×2 times Total time: 4min.(IR-reflow)	= EIAJED-4701 -300(301)M(II)				
Vibration	Total peak amplitude: 1.5mm Vibration frequency: 10 to 2000 Hz Sweep period: 20 minute Vibration directions: 3 mutually perpendicular Duration: 2 hr / direc.	MIL-STD 202G method 204				
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213				
Solderability	Solder Temperature:265±5 ℃ Duration time: 5±0.5 seconds.	J-STD-002				
Environmental	characteristics					
Thermal Shock	Heat cycle conditions -40 $^{\circ}$ C (30min) \longleftrightarrow 85 $^{\circ}$ C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8				
Humidity test	Temperature : 85 ± 2 ℃ Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103				
Dry heat (Aging test)	Temperature : 125 ± 2 ℃ Duration : 168 hours	MIL-STD 202G method 108A				
Cold resistance (Low Temp Storage)	Temperature :-40 ± 2 °C Duration : 96 hours	IEC 60068-2-1				